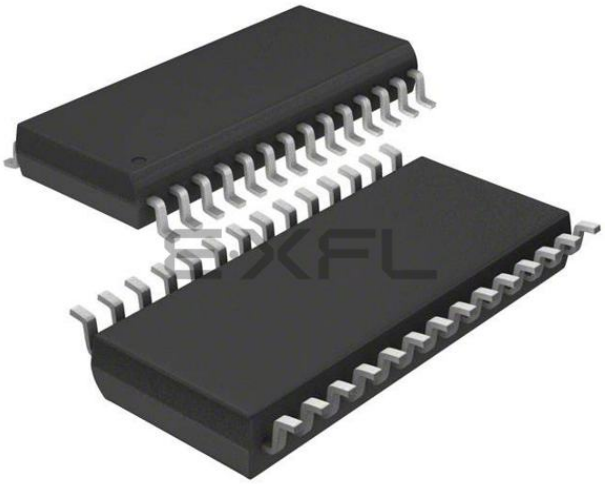

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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	M8C
Core Size	8-Bit
Speed	24MHz
Connectivity	I²C, IrDA, SPI, UART/USART
Peripherals	LVD, POR, PWM, WDT
Number of I/O	24
Program Memory Size	16KB (16K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.25V
Data Converters	A/D 4x14b; D/A 4x9b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SSOP (0.209", 5.30mm Width)
Supplier Device Package	28-SSOP
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/cy8c28452-24pvxit

Contents

More Information

Cypress provides a wealth of data at www.cypress.com to help you to select the right PSoC device for your design, and to help you to quickly and effectively integrate the device into your design. For a comprehensive list of resources, see the knowledge base article "How to Design with PSoC® 1, PowerPSoC®, and PLC – KBA88292". Following is an abbreviated list for PSoC 1:

- Overview: PSoC Portfolio, PSoC Roadmap
- Product Selectors: PSoC 1, PSoC 3, PSoC 4, PSoC 5LP
- In addition, PSoC Designer includes a device selection tool.
- Application notes: Cypress offers a large number of PSoC application notes covering a broad range of topics, from basic to advanced level. Recommended application notes for getting started with PSoC 1 are:
  - Getting Started with PSoC® 1 – AN75320
  - PSoC® 1 - Getting Started with GPIO – AN2094
  - PSoC® 1 Analog Structure and Configuration – AN74170
  - PSoC® 1 Switched Capacitor Analog Blocks – AN2041
  - Selecting Analog Ground and Reference – AN2219

Note: For CY8C28xxx devices related Application note please click here.

- Development Kits:
  - CY3210-PSoCEval1 supports all PSoC 1 Mixed-Signal Array families, including automotive, except CY8C25/26xxx devices. The kit includes an LCD module, potentiometer, LEDs, and breadboarding space.
  - CY3214-PSoCEvalUSB features a development board for the CY8C24x94 PSoC device. Special features of the board include USB and CapSense development and debugging support.

Note: For CY8C28xxx devices related Development Kits please click here.

The MiniProg1 and MiniProg3 devices provide interfaces for flash programming and debug.

PSoC Designer

PSoC Designer is a free Windows-based Integrated Design Environment (IDE). Develop your applications using a library of pre-characterized analog and digital peripherals in a drag-and-drop design environment. Then, customize your design leveraging the dynamically generated API libraries of code. Figure 1 shows PSoC Designer windows. **Note:** This is not the default view.

1. **Global Resources –** all device hardware settings.
2. **Parameters –** the parameters of the currently selected User Modules.
3. **Pinout –** information related to device pins.
4. **Chip-Level Editor –** a diagram of the resources available on the selected chip.
5. **Datasheet –** the datasheet for the currently selected UM
6. **User Modules –** all available User Modules for the selected device.
7. **Device Resource Meter –** device resource usage for the current project configuration.
8. **Workspace –** a tree level diagram of files associated with the project.
9. **Output –** output from project build and debug operations.

Note: For detailed information on PSoC Designer, go to PSoC® Designer > Help > Documentation > Designer Specific Documents > IDE User Guide.

Figure 1. PSoC Designer Layout

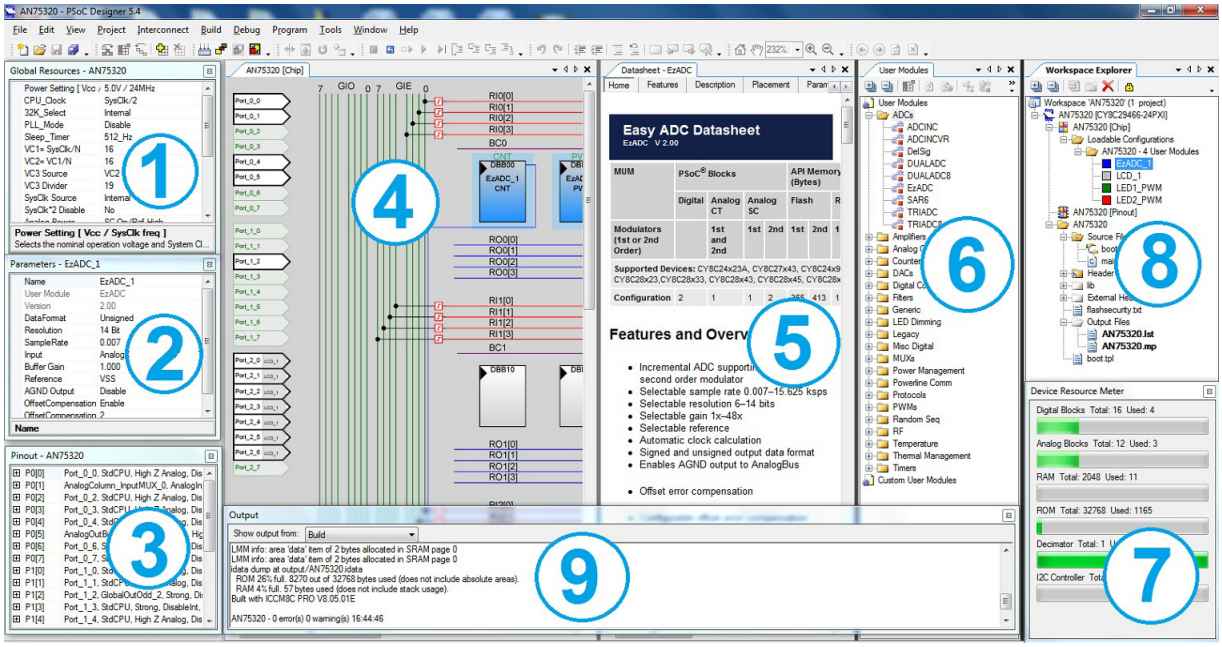


Figure 4. Analog System Block Diagram for CY8C28x43 Devices

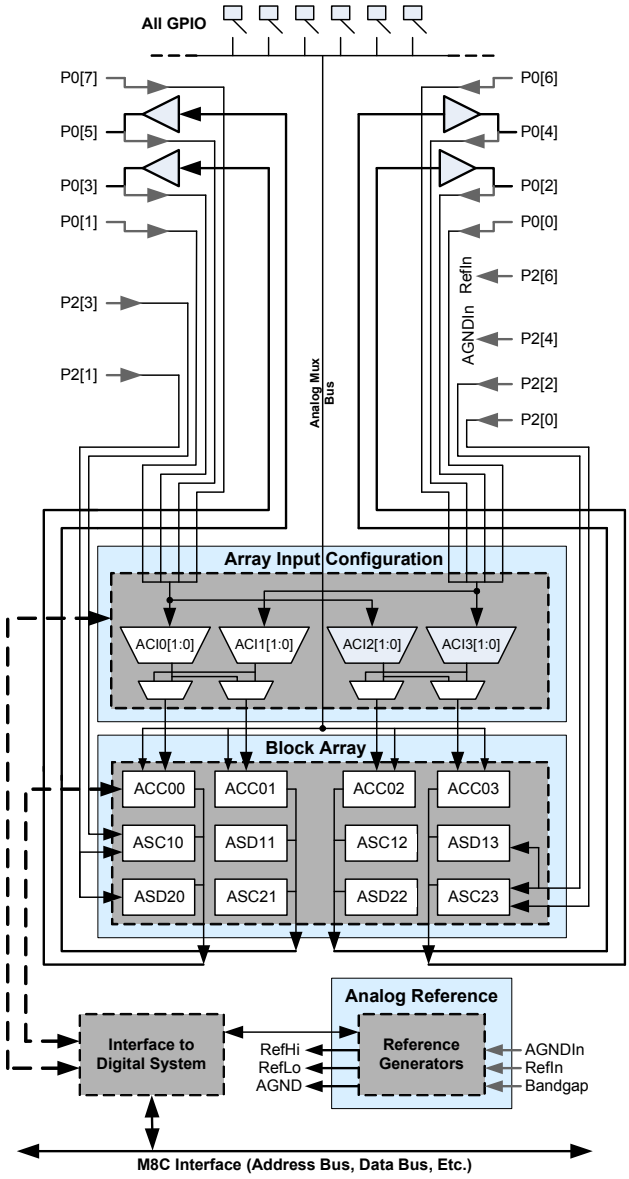
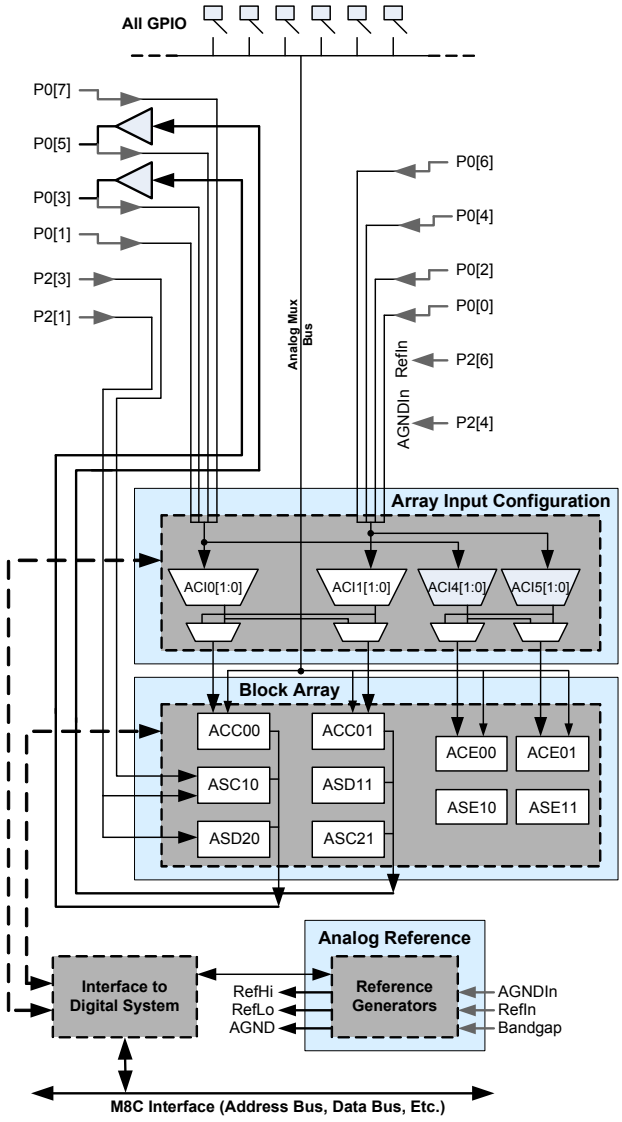


Figure 5. Analog System Block Diagram for CY8C28x33 Devices



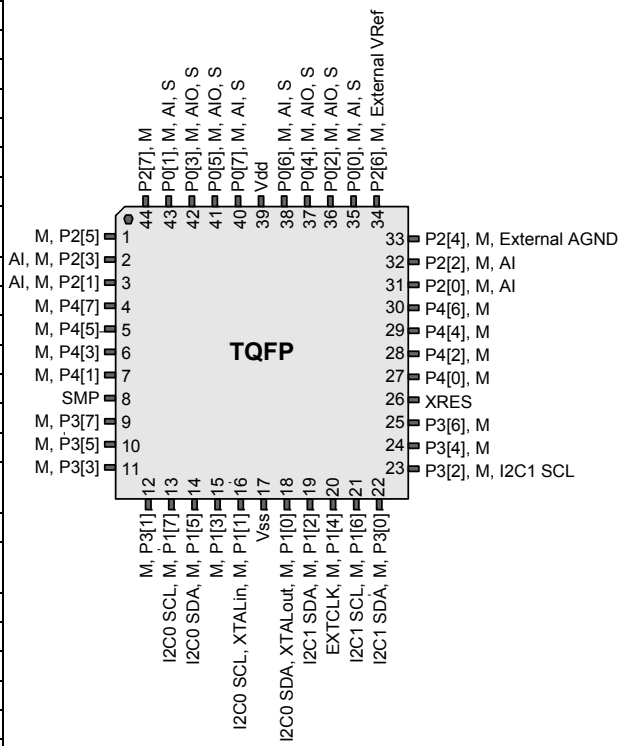
44-pin Part Pinout

Table 5. 44-pin Part Pinout (TQFP)

Pin No.	Type		Pin Name	Description
	Digital	Analog		
1	I/O	M	P2[5]	
2	I/O	I, M	P2[3]	Direct switched capacitor block input.[9]
3	I/O	I, M	P2[1]	Direct switched capacitor block input.[9]
4	I/O	M	P4[7]	
5	I/O	M	P4[5]	
6	I/O	M	P4[3]	
7	I/O	M	P4[1]	
8	Output		SMP	Switch Mode Pump (SMP) connection to external components.
9	I/O	M	P3[7]	
10	I/O	M	P3[5]	
11	I/O	M	P3[3]	
12	I/O	M	P3[1]	
13	I/O	M	P1[7]	I2C0 Serial Clock (SCL).
14	I/O	M	P1[5]	I2C0 Serial Data (SDA).
15	I/O	M	P1[3]	
16	I/O	M	P1[1]	Crystal Input (XTALin), I2C0 Serial Clock (SCL), ISSP-SCLK[4].
17	Power		V_{SS}	Ground connection.
18	I/O	M	P1[0]	Crystal Output (XTALout), I2C0 Serial Data (SDA), ISSP-SDATA[4].
19	I/O	M	P1[2]	I2C1 Serial Data (SDA).[7]
20	I/O	M	P1[4]	Optional External Clock Input (EXTCLK).
21	I/O	M	P1[6]	I2C1 Serial Clock (SCL).[7]
22	I/O	M	P3[0]	I2C1 Serial Data (SDA).[7]
23	I/O	M	P3[2]	I2C1 Serial Clock (SCL).[7]
24	I/O	M	P3[4]	
25	I/O	M	P3[6]	
26	Input		XRES	Active high external reset with internal pull-down.
27	I/O	M	P4[0]	
28	I/O	M	P4[2]	
29	I/O	M	P4[4]	
30	I/O	M	P4[6]	
31	I/O	I, M	P2[0]	Direct switched capacitor block input.[10]
32	I/O	I, M	P2[2]	Direct switched capacitor block input.[10]
33	I/O	M	P2[4]	External Analog Ground (AGND).
34	I/O	M	P2[6]	External Voltage Reference (VRef).
35	I/O	I, M, S	P0[0]	Analog column mux and SAR ADC input.[5]
36	I/O	I/O, M S	P0[2]	Analog column mux and SAR ADC input. Analog column output.[5, 8]
37	I/O	I/O, M, S	P0[4]	Analog column mux and SAR ADC input. Analog column output.[5, 8]
38	I/O	I, M, S	P0[6]	Analog column mux and SAR ADC input.[5]
39	Power		V_{DD}	Supply voltage.
40	I/O	I, M, S	P0[7]	Analog column mux and SAR ADC input.[5]
41	I/O	I/O, M, S	P0[5]	Analog column mux and SAR ADC input. Analog column output.[5, 6]
42	I/O	I/O, M, S	P0[3]	Analog column mux and SAR ADC input. Analog column output.[5, 6]
43	I/O	I, M, S	P0[1]	Analog column mux and SAR ADC input.[5]
44	I/O		P2[7]	

LEGEND: A = Analog, I = Input, O = Output, S = SAR ADC Input, and M = Analog Mux Bus Input.

CY8C28513, and CY8C28545
44-pin PSoC Devices



56-pin Part Pinout

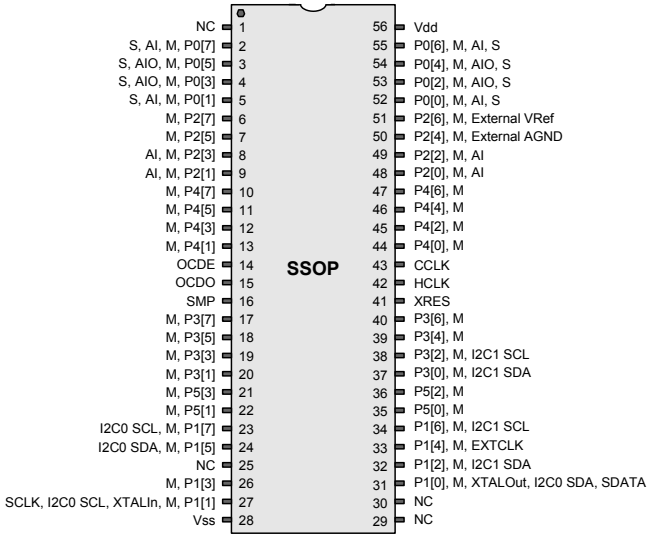
The 56-pin SSOP part is for the CY8C28000 On-Chip Debug (OCD) PSoC device.

Note This part is only used for in-circuit debugging. It is NOT available for production.

Table 7. 56-pin Part Pinout (SSOP)

Pin No.	Type		Pin Name	Description
	Digital	Analog		
1			NC	No connection.
2	I/O	I, M, S	P0[7]	Analog column mux and SAR ADC input.
3	I/O	I/O, M, S	P0[5]	Analog column mux and SAR ADC input. Analog column output.
4	I/O	I/O, M, S	P0[3]	Analog column mux and SAR ADC input. Analog column output.
5	I/O	I, M, S	P0[1]	Analog column mux and SAR ADC input.
6	I/O	M	P2[7]	
7	I/O	M	P2[5]	
8	I/O	I	P2[3]	Direct switched capacitor block input.
9	I/O	I	P2[1]	Direct switched capacitor block input.
10	I/O	M	P4[7]	
11	I/O	M	P4[5]	
12	I/O	I, M	P4[3]	
13	I/O	I, M	P4[1]	
14	OCD	M	OCDE	OCD even data I/O.
15	OCD	M	OCDO	OCD odd data output.
16	Output		SMP	Switch Mode Pump (SMP) connection to required external components.
17	I/O	M	P3[7]	
18	I/O	M	P3[5]	
19	I/O	M	P3[3]	
20	I/O	M	P3[1]	
21	I/O	M	P5[3]	
22	I/O	M	P5[1]	
23	I/O	M	P1[7]	I2C0 Serial Clock (SCL).
24	I/O	M	P1[5]	I2C0 Serial Data (SDA).
25			NC	No connection.
26	I/O	M	P1[3]	
27	I/O	M	P1[1]	Crystal Input (XTALin), I2C0 Serial Clock (SCL), ISSP-SCLK[4].
28	Power		V_{SS}	Ground connection.
29			NC	No connection.
30			NC	No connection.
31	I/O	M	P1[0]	Crystal Output (XTALout), I2C0 Serial Data (SDA), ISSP-SDATA[4].
32	I/O	M	P1[2]	I2C1 Serial Data (SDA).
33	I/O	M	P1[4]	Optional External Clock Input (EXTCLK).
34	I/O	M	P1[6]	I2C1 Serial Clock (SCL).
35	I/O	M	P5[0]	
36	I/O	M	P5[2]	
37	I/O	M	P3[0]	I2C1 Serial Data (SDA).
38	I/O	M	P3[2]	I2C1 Serial Clock (SCL).
39	I/O	M	P3[4]	
40	I/O	M	P3[6]	

CY8C28000 56-pin PSoC Device



Not for Production

Table 9. CY8C28x03 Register Map Bank 1 Table: Configuration Space

Name	Addr (1,Hex)	Access	Name	Addr (1,Hex)	Access	Name	Addr (1,Hex)	Access	Name	Addr (1,Hex)	Access
PRT0DM0	00	RW	DBC20FN	40	RW		80		RDI2RI	C0	RW
PRT0DM1	01	RW	DBC20IN	41	RW	SADC_TSCMPL	81	RW	RDI2SYN	C1	RW
PRT0IC0	02	RW	DBC20OU	42	RW	SADC_TSCMPH	82	RW	RDI2IS	C2	RW
PRT0IC1	03	RW	DBC20CR1	43	RW		83		RDI2LT0	C3	RW
PRT1DM0	04	RW	DBC21FN	44	RW		84		RDI2LT1	C4	RW
PRT1DM1	05	RW	DBC21IN	45	RW		85		RDI2RO0	C5	RW
PRT1IC0	06	RW	DBC21OU	46	RW		86		RDI2RO1	C6	RW
PRT1IC1	07	RW	DBC21CR1	47	RW		87		RDI2DSM	C7	RW
PRT2DM0	08	RW	DCC22FN	48	RW		88			C8	
PRT2DM1	09	RW	DCC22IN	49	RW		89			C9	
PRT2IC0	0A	RW	DCC22OU	4A	RW		8A			CA	
PRT2IC1	0B	RW	DCC22CR1	4B	RW		8B			CB	
PRT3DM0	0C	RW	DCC23FN	4C	RW		8C			CC	
PRT3DM1	0D	RW	DCC23IN	4D	RW		8D			CD	
PRT3IC0	0E	RW	DCC23OU	4E	RW		8E			CE	
PRT3IC1	0F	RW	DCC23CR1	4F	RW		8F			CF	
PRT4DM0	10	RW		50			90		GDI_O_IN	D0	RW
PRT4DM1	11	RW		51			91		GDI_E_IN	D1	RW
PRT4IC0	12	RW		52			92		GDI_O_OU	D2	RW
PRT4IC1	13	RW		53			93		GDI_E_OU	D3	RW
PRT5DM0	14	RW		54			94			D4	
PRT5DM1	15	RW		55			95			D5	
PRT5IC0	16	RW		56			96			D6	
PRT5IC1	17	RW		57			97			D7	
	18			58			98			D8	
	19			59			99			D9	
	1A			5A			9A			DA	
	1B			5B			9B			DB	
	1C			5C			9C			DC	
	1D			5D			9D		OSC_GO_EN	DD	RW
	1E			5E			9E		OSC_CR4	DE	RW
	1F			5F			9F		OSC_CR3	DF	RW
DBC00FN	20	RW		60		GDI_O_IN_CR	A0	RW	OSC_CR0	E0	RW
DBC00IN	21	RW		61		GDI_E_IN_CR	A1	RW	OSC_CR1	E1	RW
DBC00OU	22	RW		62		GDI_O_OU_CR	A2	RW	OSC_CR2	E2	RW
DBC00CR1	23	RW		63		GDI_E_OU_CR	A3	RW	VLT_CR	E3	RW
DBC01FN	24	RW		64		RTC_H	A4	RW	VLT_CMP	E4	RW
DBC01IN	25	RW		65		RTC_M	A5	RW		E5	
DBC01OU	26	RW		66		RTC_S	A6	RW		E6	
DBC01CR1	27	RW		67		RTC_CR	A7	RW		E7	
DCC02FN	28	RW		68		SADC_CR0	A8	RW	IMO_TR	E8	RW
DCC02IN	29	RW		69		SADC_CR1	A9	RW	ILO_TR	E9	RW
DCC02OU	2A	RW		6A		SADC_CR2	AA	RW	BDG_TR	EA	RW
DCC02CR1	2B	RW	I2C1_CFG	6B	RW	SADC_CR3	AB	RW	ECO_TR	EB	RW
DCC03FN	2C	RW	TMP_DR0	6C	RW	SADC_CR4	AC	RW		EC	
DCC03IN	2D	RW	TMP_DR1	6D	RW	I2C0_ADDR	AD	RW		ED	
DCC03OU	2E	RW	TMP_DR2	6E	RW	I2C1_ADDR	AE	RW		EE	
DCC03CR1	2F	RW	TMP_DR3	6F	RW	AMUX_CLK	AF	RW		EF	
DBC10FN	30	RW		70		RDI0RI	B0	RW		F0	
DBC10IN	31	RW	SADC_TSCR0	71	RW	RDI0SYN	B1	RW		F1	
DBC10OU	32	RW	SADC_TSCR1	72	RW	RDI0IS	B2	RW		F2	
DBC10CR1	33	RW		73		RDI0LT0	B3	RW		F3	
DBC11FN	34	RW		74		RDI0LT1	B4	RW		F4	
DBC11IN	35	RW		75		RDI0RO0	B5	RW		F5	
DBC11OU	36	RW		76		RDI0RO1	B6	RW		F6	
DBC11CR1	37	RW		77		RDIODSM	B7	RW	CPU_F	F7	RL
DCC12FN	38	RW		78		RDI1RI	B8	RW		F8	
DCC12IN	39	RW		79		RDI1SYN	B9	RW		F9	
DCC12OU	3A	RW		7A		RDI1IS	BA	RW	FLS_PR1	FA	RW
DCC12CR1	3B	RW		7B		RDI1LT0	BB	RW		FB	
DCC13FN	3C	RW		7C		RDI1LT1	BC	RW		FC	
DCC13IN	3D	RW		7D		RDI1RO0	BD	RW		FD	
DCC13OU	3E	RW		7E		RDI1RO1	BE	RW	CPU_SCR1	FE	#
DCC13CR1	3F	RW		7F		RDI1DSM	BF	RW	CPU_SCR0	FF	#

Blank fields are Reserved and should not be accessed. # Access is bit specific. *Address has a dual purpose, see “Mapping Exceptions” on page 251

Table 11. CY8C28x13 Register Map Bank 1 Table: Configuration Space

Name	Addr (1,Hex)	Access	Name	Addr (1,Hex)	Access	Name	Addr (1,Hex)	Access	Name	Addr (1,Hex)	Access
PRT0DM0	00	RW	DBC20FN	40	RW		80		RDI2RI	C0	RW
PRT0DM1	01	RW	DBC20IN	41	RW	SADC_TSCMPL	81	RW	RDI2SYN	C1	RW
PRT0IC0	02	RW	DBC20OU	42	RW	SADC_TSCMPH	82	RW	RDI2IS	C2	RW
PRT0IC1	03	RW	DBC20CR1	43	RW	ACE_AMD_CR1	83	RW	RDI2LT0	C3	RW
PRT1DM0	04	RW	DBC21FN	44	RW		84		RDI2LT1	C4	RW
PRT1DM1	05	RW	DBC21IN	45	RW	ACE_PWM_CR	85	RW	RDI2RO0	C5	RW
PRT1IC0	06	RW	DBC21OU	46	RW	ACE_ADC0_CR	86	RW	RDI2RO1	C6	RW
PRT1IC1	07	RW	DBC21CR1	47	RW	ACE_ADC1_CR	87	RW	RDI2DSM	C7	RW
PRT2DM0	08	RW	DCC22FN	48	RW		88			C8	
PRT2DM1	09	RW	DCC22IN	49	RW	ACE_CLK_CR0	89	RW		C9	
PRT2IC0	0A	RW	DCC22OU	4A	RW	ACE_CLK_CR1	8A	RW		CA	
PRT2IC1	0B	RW	DCC22CR1	4B	RW	ACE_CLK_CR3	8B	RW		CB	
PRT3DM0	0C	RW	DCC23FN	4C	RW		8C	RW		CC	
PRT3DM1	0D	RW	DCC23IN	4D	RW	ACE01CR1	8D	RW		CD	
PRT3IC0	0E	RW	DCC23OU	4E	RW	ACE01CR2	8E	RW		CE	
PRT3IC1	0F	RW	DCC23CR1	4F	RW	ASE11CR0	8F	RW		CF	
PRT4DM0	10	RW		50			90		GDI_O_IN	D0	RW
PRT4DM1	11	RW		51		DEC0_CR0	91	RW	GDI_E_IN	D1	RW
PRT4IC0	12	RW		52		DEC_CR3	92	RW	GDI_O_OU	D2	RW
PRT4IC1	13	RW		53			93		GDI_E_OU	D3	RW
PRT5DM0	14	RW		54			94		DEC0_CR	D4	RW
PRT5DM1	15	RW		55		DEC1_CR0	95	RW	DEC1_CR	D5	RW
PRT5IC0	16	RW		56			96			D6	
PRT5IC1	17	RW		57			97			D7	
	18			58			98		MUX_CR0	D8	RW
	19			59			99		MUX_CR1	D9	RW
	1A			5A		DEC_CR5	9A	RW	MUX_CR2	DA	RW
	1B			5B			9B		MUX_CR3	DB	RW
	1C			5C			9C		IDAC_CR1	DC	RW
	1D			5D			9D		OSC_GO_EN	DD	RW
	1E			5E			9E		OSC_CR4	DE	RW
	1F			5F			9F		OSC_CR3	DF	RW
DBC00FN	20	RW		60		GDI_O_IN_CR	A0	RW	OSC_CR0	E0	RW
DBC00IN	21	RW		61		GDI_E_IN_CR	A1	RW	OSC_CR1	E1	RW
DBC00OU	22	RW		62		GDI_O_OU_CR	A2	RW	OSC_CR2	E2	RW
DBC00CR1	23	RW		63		GDI_E_OU_CR	A3	RW	VLT_CR	E3	RW
DBC01FN	24	RW		64		RTC_H	A4	RW	VLT_CMP	E4	RW
DBC01IN	25	RW		65		RTC_M	A5	RW	ADC0_TR	E5	RW
DBC01OU	26	RW		66		RTC_S	A6	RW	ADC1_TR	E6	RW
DBC01CR1	27	RW		67		RTC_CR	A7	RW	IDAC_CR2	E7	RW
DCC02FN	28	RW		68		SADC_CR0	A8	RW	IMO_TR	E8	RW
DCC02IN	29	RW		69		SADC_CR1	A9	RW	ILO_TR	E9	RW
DCC02OU	2A	RW	AMUX_CFG1	6A	RW	SADC_CR2	AA	RW	BDG_TR	EA	RW
DCC02CR1	2B	RW		6B		SADC_CR3	AB	RW	ECO_TR	EB	RW
DCC03FN	2C	RW	TMP_DR0	6C	RW	SADC_CR4	AC	RW	MUX_CR4	EC	RW
DCC03IN	2D	RW	TMP_DR1	6D	RW	I2C0_ADDR	AD	RW	MUX_CR5	ED	RW
DCC03OU	2E	RW	TMP_DR2	6E	RW		AE			EE	
DCC03CR1	2F	RW	TMP_DR3	6F	RW	AMUX_CLK	AF	RW		EF	
DBC10FN	30	RW		70		RDI0RI	B0	RW		F0	
DBC10IN	31	RW	SADC_TSCR0	71	RW	RDI0SYN	B1	RW		F1	
DBC10OU	32	RW	SADC_TSCR1	72	RW	RDI0IS	B2	RW		F2	
DBC10CR1	33	RW	ACE_AMD_CR0	73	RW	RDI0LT0	B3	RW		F3	
DBC11FN	34	RW		74	RW	RDI0LT1	B4	RW		F4	
DBC11IN	35	RW	ACE_AMX_IN	75	RW	RDI0RO0	B5	RW		F5	
DBC11OU	36	RW	ACE_CMP_CR0	76	RW	RDI0RO1	B6	RW		F6	
DBC11CR1	37	RW	ACE_CMP_CR1	77	RW	RDIODSM	B7	RW	CPU_F	F7	RL
DCC12FN	38	RW		78		RDI1RI	B8	RW		F8	
DCC12IN	39	RW	ACE_CMP_GI_EN	79	RW	RDI1SYN	B9	RW		F9	
DCC12OU	3A	RW	ACE_ALT_CR0	7A	RW	RDI1IS	BA	RW	FLS_PR1	FA	RW
DCC12CR1	3B	RW	ACE_ABF_CR0	7B	RW	RDI1LT0	BB	RW		FB	
DCC13FN	3C	RW		7C		RDI1LT1	BC	RW		FC	
DCC13IN	3D	RW	ACE0_CR1	7D	RW	RDI1RO0	BD	RW	IDAC_CR0	FD	RW
DCC13OU	3E	RW	ACE0_CR2	7E	RW	RDI1RO1	BE	RW	CPU_SCR1	FE	#
DCC13CR1	3F	RW	ACE0_CR3	7F	RW	RDI1DSM	BF	RW	CPU_SCR0	FF	#

Blank fields are Reserved and should not be accessed. # Access is bit specific. *Address has a dual purpose, see “Mapping Exceptions” on page 251

Table 13. CY8C28x23 Register Map Bank 1 Table: Configuration Space

Name	Addr (1,Hex)	Access	Name	Addr (1,Hex)	Access	Name	Addr (1,Hex)	Access	Name	Addr (1,Hex)	Access
PRT0DM0	00	RW	DBC20FN	40	RW		80		RDI2RI	C0	RW
PRT0DM1	01	RW	DBC20IN	41	RW		81		RDI2SYN	C1	RW
PRT0IC0	02	RW	DBC20OU	42	RW		82		RDI2IS	C2	RW
PRT0IC1	03	RW	DBC20CR1	43	RW		83		RDI2LT0	C3	RW
PRT1DM0	04	RW	DBC21FN	44	RW		84		RDI2LT1	C4	RW
PRT1DM1	05	RW	DBC21IN	45	RW		85		RDI2RO0	C5	RW
PRT1IC0	06	RW	DBC21OU	46	RW		86		RDI2RO1	C6	RW
PRT1IC1	07	RW	DBC21CR1	47	RW		87		RDI2DSM	C7	RW
PRT2DM0	08	RW	DCC22FN	48	RW		88			C8	
PRT2DM1	09	RW	DCC22IN	49	RW		89			C9	
PRT2IC0	0A	RW	DCC22OU	4A	RW		8A			CA	
PRT2IC1	0B	RW	DCC22CR1	4B	RW		8B			CB	
PRT3DM0	0C	RW	DCC23FN	4C	RW		8C			CC	
PRT3DM1	0D	RW	DCC23IN	4D	RW		8D			CD	
PRT3IC0	0E	RW	DCC23OU	4E	RW		8E			CE	
PRT3IC1	0F	RW	DCC23CR1	4F	RW		8F			CF	
PRT4DM0	10	RW		50			90		GDI_O_IN	D0	RW
PRT4DM1	11	RW		51		DEC0_CR0	91	RW	GDI_E_IN	D1	RW
PRT4IC0	12	RW		52		DEC_CR3	92	RW	GDI_O_OU	D2	RW
PRT4IC1	13	RW		53			93	RW	GDI_E_OU	D3	RW
PRT5DM0	14	RW		54			94	RW	DEC0_CR	D4	RW
PRT5DM1	15	RW		55		DEC1_CR0	95	RW	DEC1_CR	D5	RW
PRT5IC0	16	RW		56			96			D6	
PRT5IC1	17	RW		57			97			D7	
	18			58			98			D8	
	19			59			99			D9	
	1A			5A		DEC_CR5	9A	RW		DA	
	1B			5B			9B			DB	
	1C			5C			9C			DC	
	1D			5D			9D		OSC_GO_EN	DD	RW
	1E			5E			9E		OSC_CR4	DE	RW
	1F			5F			9F		OSC_CR3	DF	RW
DBC00FN	20	RW	CLK_CR0	60	RW	GDI_O_IN_CR	A0	RW	OSC_CR0	E0	RW
DBC00IN	21	RW	CLK_CR1	61	RW	GDI_E_IN_CR	A1	RW	OSC_CR1	E1	RW
DBC00OU	22	RW	ABF_CR0	62	RW	GDI_O_OU_CR	A2	RW	OSC_CR2	E2	RW
DBC00CR1	23	RW	AMD_CR0	63	RW	GDI_E_OU_CR	A3	RW	VLT_CR	E3	RW
DBC01FN	24	RW	CMP_GO_EN	64	RW	RTC_H	A4	RW	VLT_CMP	E4	RW
DBC01IN	25	RW		65		RTC_M	A5	RW		E5	
DBC01OU	26	RW	AMD_CR1	66	RW	RTC_S	A6	RW		E6	
DBC01CR1	27	RW	ALT_CR0	67	RW	RTC_CR	A7	RW		E7	
DCC02FN	28	RW		68			A8		IMO_TR	E8	RW
DCC02IN	29	RW	CLK_CR2	69	RW		A9		ILO_TR	E9	RW
DCC02OU	2A	RW		6A			AA		BDG_TR	EA	RW
DCC02CR1	2B	RW	I2C1_CFG	6B	RW		AB		ECO_TR	EB	RW
DCC03FN	2C	RW	TMP_DR0	6C	RW		AC			EC	
DCC03IN	2D	RW	TMP_DR1	6D	RW	I2C0_ADDR	AD	RW		ED	
DCC03OU	2E	RW	TMP_DR2	6E	RW	I2C1_ADDR	AE	RW		EE	
DCC03CR1	2F	RW	TMP_DR3	6F	RW	AMUX_CLK	AF	RW		EF	
DBC10FN	30	RW		70		RDI0RI	B0	RW		F0	
DBC10IN	31	RW		71		RDI0SYN	B1	RW		F1	
DBC10OU	32	RW		72		RDI0IS	B2	RW		F2	
DBC10CR1	33	RW		73		RDI0LT0	B3	RW		F3	
DBC11FN	34	RW		74		RDI0LT1	B4	RW		F4	
DBC11IN	35	RW		75		RDI0RO0	B5	RW		F5	
DBC11OU	36	RW		76		RDI0RO1	B6	RW		F6	
DBC11CR1	37	RW		77		RDIODSM	B7	RW	CPU_F	F7	RL
DCC12FN	38	RW		78		RDI1RI	B8	RW		F8	
DCC12IN	39	RW		79		RDI1SYN	B9	RW		F9	
DCC12OU	3A	RW		7A		RDI1IS	BA	RW	FLS_PR1	FA	RW
DCC12CR1	3B	RW		7B		RDI1LT0	BB	RW		FB	
DCC13FN	3C	RW		7C		RDI1LT1	BC	RW		FC	
DCC13IN	3D	RW		7D		RDI1RO0	BD	RW		FD	
DCC13OU	3E	RW		7E		RDI1RO1	BE	RW	CPU_SCR1	FE	#
DCC13CR1	3F	RW		7F		RDI1DSM	BF	RW	CPU_SCR0	FF	#

Blank fields are Reserved and should not be accessed. # Access is bit specific. *Address has a dual purpose, see “Mapping Exceptions” on page 251

Table 19. CY8C28x45 Register Map Bank 1 Table: Configuration Space

Name	Addr (1,Hex)	Access	Name	Addr (1,Hex)	Access	Name	Addr (1,Hex)	Access	Name	Addr (1,Hex)	Access
PRT0DM0	00	RW	DBC20FN	40	RW		80	RW	RDI2RI	C0	RW
PRT0DM1	01	RW	DBC20IN	41	RW	SADC_TSCMPL	81	RW	RDI2SYN	C1	RW
PRT0IC0	02	RW	DBC20OU	42	RW	SADC_TSCMPH	82	RW	RDI2IS	C2	RW
PRT0IC1	03	RW	DBC20CR1	43	RW	ACE_AMD_CR1	83	RW	RDI2LT0	C3	RW
PRT1DM0	04	RW	DBC21FN	44	RW		84	RW	RDI2LT1	C4	RW
PRT1DM1	05	RW	DBC21IN	45	RW	ACE_PWM_CR	85	RW	RDI2RO0	C5	RW
PRT1IC0	06	RW	DBC21OU	46	RW	ACE_ADC0_CR	86	RW	RDI2RO1	C6	RW
PRT1IC1	07	RW	DBC21CR1	47	RW	ACE_ADC1_CR	87	RW	RDI2DSM	C7	RW
PRT2DM0	08	RW	DCC22FN	48	RW		88	RW		C8	
PRT2DM1	09	RW	DCC22IN	49	RW	ACE_CLK_CR0	89	RW		C9	
PRT2IC0	0A	RW	DCC22OU	4A	RW	ACE_CLK_CR1	8A	RW		CA	
PRT2IC1	0B	RW	DCC22CR1	4B	RW	ACE_CLK_CR3	8B	RW		CB	
PRT3DM0	0C	RW	DCC23FN	4C	RW		8C	RW		CC	
PRT3DM1	0D	RW	DCC23IN	4D	RW	ACE01CR1	8D	RW		CD	
PRT3IC0	0E	RW	DCC23OU	4E	RW	ACE01CR2	8E	RW		CE	
PRT3IC1	0F	RW	DCC23CR1	4F	RW	ASE11CR0	8F	RW		CF	
PRT4DM0	10	RW		50			90		GDI_O_IN	D0	RW
PRT4DM1	11	RW		51		DEC0_CR0	91	RW	GDI_E_IN	D1	RW
PRT4IC0	12	RW		52		DEC_CR3	92	RW	GDI_O_OU	D2	RW
PRT4IC1	13	RW		53			93		GDI_E_OU	D3	RW
PRT5DM0	14	RW		54			94		DEC0_CR	D4	RW
PRT5DM1	15	RW		55		DEC1_CR0	95	RW	DEC1_CR	D5	RW
PRT5IC0	16	RW		56		DEC_CR4	96	RW	DEC2_CR	D6	RW
PRT5IC1	17	RW		57			97		DEC3_CR	D7	RW
	18			58			98		MUX_CR0	D8	RW
	19			59		DEC2_CR0	99	RW	MUX_CR1	D9	RW
	1A			5A		DEC_CR5	9A	RW	MUX_CR2	DA	RW
	1B			5B			9B		MUX_CR3	DB	RW
	1C			5C			9C		IDAC_CR1	DC	RW
	1D			5D		DEC3_CR0	9D	RW	OSC_GO_EN	DD	RW
	1E			5E			9E		OSC_CR4	DE	RW
	1F			5F			9F		OSC_CR3	DF	RW
DBC00FN	20	RW	CLK_CR0	60	RW	GDI_O_IN_CR	A0	RW	OSC_CR0	E0	RW
DBC00IN	21	RW	CLK_CR1	61	RW	GDI_E_IN_CR	A1	RW	OSC_CR1	E1	RW
DBC00OU	22	RW	ABF_CR0	62	RW	GDI_O_OU_CR	A2	RW	OSC_CR2	E2	RW
DBC00CR1	23	RW	AMD_CR0	63	RW	GDI_E_OU_CR	A3	RW	VLT_CR	E3	RW
DBC01FN	24	RW	CMP_GO_EN	64	RW	RTC_H	A4	RW	VLT_CMP	E4	RW
DBC01IN	25	RW	CMP_GO_EN1	65	RW	RTC_M	A5	RW	ADC0_TR	E5	RW
DBC01OU	26	RW	AMD_CR1	66	RW	RTC_S	A6	RW	ADC1_TR	E6	RW
DBC01CR1	27	RW	ALT_CR0	67	RW	RTC_CR	A7	RW	IDAC_CR2	E7	RW
DCC02FN	28	RW	ALT_CR1	68	RW	SADC_CR0	A8	RW	IMO_TR	E8	RW
DCC02IN	29	RW	CLK_CR2	69	RW	SADC_CR1	A9	RW	ILO_TR	E9	RW
DCC02OU	2A	RW	AMUX_CFG1	6A	RW	SADC_CR2	AA	RW	BDG_TR	EA	RW
DCC02CR1	2B	RW	I2C1_CFG	6B	RW	SADC_CR3	AB	RW	ECO_TR	EB	RW
DCC03FN	2C	RW	TMP_DR0	6C	RW	SADC_CR4	AC	RW	MUX_CR4	EC	RW
DCC03IN	2D	RW	TMP_DR1	6D	RW	I2C0_ADDR	AD	RW	MUX_CR5	ED	RW
DCC03OU	2E	RW	TMP_DR2	6E	RW	I2C1_ADDR	AE	RW		EE	
DCC03CR1	2F	RW	TMP_DR3	6F	RW	AMUX_CLK	AF	RW		EF	
DBC10FN	30	RW		70		RDI0RI	B0	RW		F0	
DBC10IN	31	RW	SADC_TSCR0	71	RW	RDI0SYN	B1	RW		F1	
DBC10OU	32	RW	SADC_TSCR1	72	RW	RDI0IS	B2	RW		F2	
DBC10CR1	33	RW	ACE_AMD_CR0	73	RW	RDI0LT0	B3	RW		F3	
DBC11FN	34	RW		74		RDI0LT1	B4	RW		F4	
DBC11IN	35	RW	ACE_AMX_IN	75	RW	RDI0RO0	B5	RW		F5	
DBC11OU	36	RW	ACE_CMP_CR0	76	RW	RDI0RO1	B6	RW		F6	
DBC11CR1	37	RW	ACE_CMP_CR1	77	RW	RDIODSM	B7	RW	CPU_F	F7	RL
DCC12FN	38	RW		78		RDI1RI	B8	RW		F8	
DCC12IN	39	RW	ACE_CMP_GI_EN	79	RW	RDI1SYN	B9	RW		F9	
DCC12OU	3A	RW	ACE_ALT_CR0	7A	RW	RDI1IS	BA	RW	FLS_PR1	FA	RW
DCC12CR1	3B	RW	ACE_ABF_CR0	7B	RW	RDI1LT0	BB	RW		FB	
DCC13FN	3C	RW		7C		RDI1LT1	BC	RW		FC	
DCC13IN	3D	RW	ACE0_CR1	7D	RW	RDI1RO0	BD	RW	IDAC_CR0	FD	RW
DCC13OU	3E	RW	ACE0_CR2	7E	RW	RDI1RO1	BE	RW	CPU_SCR1	FE	#
DCC13CR1	3F	RW	ACE0_CR3	7F	RW	RDI1DSM	BF	RW	CPU_SCR0	FF	#

Blank fields are Reserved and should not be accessed. # Access is bit specific. *Address has a dual purpose, see “Mapping Exceptions” on page 251

Table 27. 3.3 V DC Operational Amplifier Specifications

Symbol	Description	Min	Typ	Max	Units	Notes
V_{OSOACT}	Input Offset Voltage CT Blocks (absolute value) Power = Low, Opamp bias = High Power = Medium, Opamp bias = High Power = High, Opamp bias = High	 – – –	 1.65 1.32 –	 8 8 –	 mV mV mV	
V_{OSOA}	Input Offset Voltage SC and AGND (absolute value)	–	1	6	mV	Applies to High and Low Opamp bias.
TCV_{OSOA}	Average Input Offset Voltage Drift	–	7.0	35.0	µV/°C	
I_{EBOA}	Input Leakage Current (Port 0 Analog Pins)	–	200	–	pA	Gross tested to 1 µA.
C_{INOA}	Input Capacitance (Port 0 Analog Pins)	–	4.5	9.5	pF	Package and pin dependent. Temp = 25 °C.
V_{CMOA}	Common Mode Voltage Range	0.2	–	V_{DD} – 0.2	V	The common-mode input voltage range is measured through an analog output buffer. The specification includes the limitations imposed by the characteristics of the analog output buffer.
$CMRR_{OA}$	Common Mode Rejection Ratio Power = Low Power = Medium Power = High	 50 50 50	 – – –	 – – –	 dB dB dB	
G_{OLOA}	Open Loop Gain Power = Low Power = Medium Power = High	 60 60 80	 – – –	 – – –	 dB dB dB	
$V_{OHIGHOA}$	High Output Voltage Swing (internal signals) Power = Low Power = Medium Power = High is 5 V only	 V_{DD} – 0.2 V_{DD} – 0.2 V_{DD} – 0.2	 – – –	 – – –	 V V V	
V_{OLOWOA}	Low Output Voltage Swing (internal signals) Power = Low Power = Medium Power = High	 – – –	 – – –	 0.2 0.2 0.2	 V V V	
I_{SOA}	Supply Current (including associated AGND buffer) Power = Low, Opamp bias = Low Power = Low, Opamp bias = High Power = Medium, Opamp bias = Low Power = Medium, Opamp bias = High Power = High, Opamp bias = Low Power = High, Opamp bias = High	 – – – – – –	 200 400 700 1400 2400 4600	 300 600 1000 2000 3600 7500	 µA µA µA µA µA µA	
$PSRR_{OA}$	Supply Voltage Rejection Ratio	50	80	–	dB	$V_{SS} \le V_{IN} \le (V_{DD} – 2.25\ V)$ or $(V_{DD} – 1.25\ V) \le V_{IN} \le V_{DD}$.

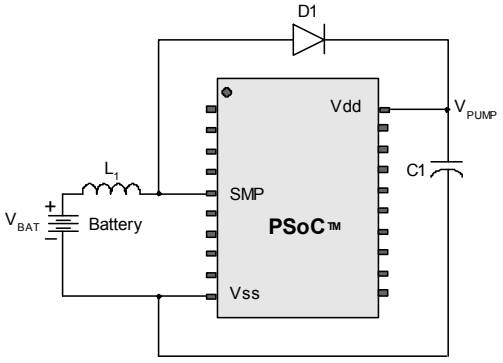
DC Switch Mode Pump Specifications

The following table lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and –40 °C ≤ T_A ≤ 85 °C, or 3.0 V to 3.6 V and –40 °C ≤ T_A ≤ 85 °C, respectively. Typical parameters apply to 5 V and 3.3 V at 25 °C and are for design guidance only.

Table 33. DC Switch Mode Pump (SMP) Specifications

Symbol	Description	Min	Typ	Max	Units	Notes
V_{PUMP} 5 V	5 V output voltage	4.75	5.0	5.25	V	Configuration of footnote.[14] Average, neglecting ripple. SMP trip voltage is set to 5.0 V.
V_{PUMP} 3 V	3 V output voltage	3.00	3.25	3.60	V	Configuration of footnote.[14] Average, neglecting ripple. SMP trip voltage is set to 3.25 V.
I_{PUMP}	Available output current V_{BAT} = 1.5 V, V_{PUMP} = 3.25 V V_{BAT} = 1.8 V, V_{PUMP} = 5.0 V	 8 5	 – –	 – –	 mA mA	Configuration of footnote.[14] SMP trip voltage is set to 3.25 V. SMP trip voltage is set to 5.0 V.
V_{BAT}5 V	Input voltage range from battery	1.8	–	5.0	V	Configuration of footnote.[14] SMP trip voltage is set to 5.0 V.
V_{BAT}3 V	Input voltage range from battery	1.5	–	3.3	V	Configuration of footnote.[14] SMP trip voltage is set to 3.25 V.
$V_{BATSTART}$	Minimum input voltage from battery to start pump	2.6	–	–	V	Configuration of footnote.[14]
ΔV_{PUMP_Line}	Line regulation (over V_{BAT} range)	–	5	–	$\%V_O$	Configuration of footnote.[14] V_O is the "V_{DD} Value for PUMP Trip" specified by the VM[2:0] setting in the DC POR and LVD Specification, Table 40 on page 52.
ΔV_{PUMP_Load}	Load regulation	–	5	–	$\%V_O$	Configuration of footnote.[14] V_O is the "V_{DD} Value for PUMP Trip" specified by the VM[2:0] setting in the DC POR and LVD Specification, Table 40 on page 52.
ΔV_{PUMP_Ripple}	Output voltage ripple (depends on capacitor/load)	–	100	–	mVpp	Configuration of footnote.[14] Load is 5mA.
E_3	Efficiency	35	50	–	%	Configuration of footnote.[14] Load is 5 mA. SMP trip voltage is set to 3.25 V.
F_{PUMP}	Switching frequency	–	1.3	–	MHz	
DC_{PUMP}	Switching duty cycle	–	50	–	%	

Figure 9. Basic Switch Mode Pump Circuit



Note
14. L_1 = 2 µH inductor, C_1 = 10 µF capacitor, D_1 = Schottky diode. See Figure 9.

Table 34. 5-V DC Analog Reference Specifications *(continued)*

Reference ARF_CR [5:3]	Reference Power Settings	Symbol	Reference	Description	Min	Typ	Max	Units
0b101	RefPower = High Opamp bias = High	V_{REFHI}	Ref high	P2[4] + Bandgap (P2[4] = V_{DD}/2)	P2[4] + 1.218	P2[4] + 1.283	P2[4] + 1.344	V
		V_{AGND}	AGND	P2[4]	P2[4]	P2[4]	P2[4]	–
		V_{REFLO}	Ref low	P2[4] – Bandgap (P2[4] = V_{DD}/2)	P2[4] – 1.329	P2[4] – 1.297	P2[4] – 1.265	V
	RefPower = High Opamp bias = Low	V_{REFHI}	Ref high	P2[4] + Bandgap (P2[4] = V_{DD}/2)	P2[4] + 1.225	P2[4] + 1.287	P2[4] + 1.346	V
		V_{AGND}	AGND	P2[4]	P2[4]	P2[4]	P2[4]	–
		V_{REFLO}	Ref low	P2[4] – Bandgap (P2[4] = V_{DD}/2)	P2[4] – 1.330	P2[4] – 1.301	P2[4] – 1.271	V
	RefPower = Medium Opamp bias = High	V_{REFHI}	Ref high	P2[4] + Bandgap (P2[4] = V_{DD}/2)	P2[4] + 1.226	P2[4] + 1.288	P2[4] + 1.346	V
		V_{AGND}	AGND	P2[4]	P2[4]	P2[4]	P2[4]	–
		V_{REFLO}	Ref low	P2[4] – Bandgap (P2[4] = V_{DD}/2)	P2[4] – 1.330	P2[4] – 1.302	P2[4] – 1.272	V
	RefPower = Medium Opamp bias = Low	V_{REFHI}	Ref high	P2[4] + Bandgap (P2[4] = V_{DD}/2)	P2[4] + 1.227	P2[4] + 1.289	P2[4] + 1.347	V
		V_{AGND}	AGND	P2[4]	P2[4]	P2[4]	P2[4]	–
		V_{REFLO}	Ref low	P2[4] – Bandgap (P2[4] = V_{DD}/2)	P2[4] – 1.331	P2[4] – 1.303	P2[4] – 1.273	V
0b110	RefPower = High Opamp bias = High	V_{REFHI}	Ref high	2 × Bandgap	2.506	2.597	2.674	V
		V_{AGND}	AGND	Bandgap	1.263	1.302	1.336	V
		V_{REFLO}	Ref low	V_{SS}	V_{SS}	V_{SS} + 0.006	V_{SS} + 0.014	V
	RefPower = High Opamp bias = Low	V_{REFHI}	Ref high	2 × Bandgap	2.508	2.595	2.675	V
		V_{AGND}	AGND	Bandgap	1.263	1.302	1.336	V
		V_{REFLO}	Ref low	V_{SS}	V_{SS}	V_{SS} + 0.003	V_{SS} + 0.008	V
	RefPower = Medium Opamp bias = High	V_{REFHI}	Ref high	2 × Bandgap	2.508	2.595	2.676	V
		V_{AGND}	AGND	Bandgap	1.263	1.302	1.336	V
		V_{REFLO}	Ref low	V_{SS}	V_{SS}	V_{SS} + 0.002	V_{SS} + 0.005	V
	RefPower = Medium Opamp bias = Low	V_{REFHI}	Ref high	2 × Bandgap	2.508	2.596	2.677	V
		V_{AGND}	AGND	Bandgap	1.263	1.302	1.336	V
		V_{REFLO}	Ref low	V_{SS}	V_{SS}	V_{SS} + 0.001	V_{SS} + 0.003	V

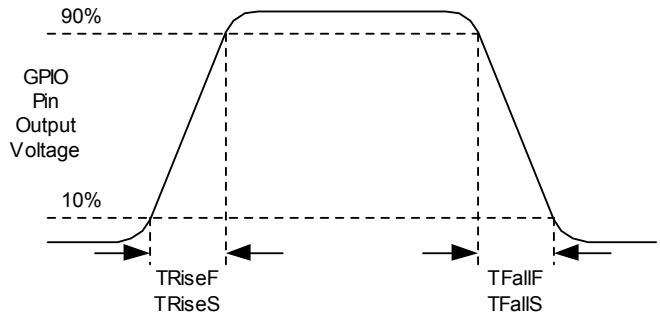
AC GPIO Specifications

The following table lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and –40 °C ≤ T_A ≤ 85 °C, or 3.0 V to 3.6 V and –40 °C ≤ T_A ≤ 85 °C, respectively. Typical parameters apply to 5 V and 3.3 V at 25 °C and are for design guidance only.

Table 44. AC GPIO Specifications

Symbol	Description	Min	Typ	Max	Units	Notes
F_{GPIO}	GPIO Operating Frequency	0	–	12.3	MHz	Normal Strong Mode
t_{RiseF}	Rise Time, Normal Strong Mode, Cload = 50 pF	3	–	18	ns	V_{DD} = 4.5 to 5.25 V, 10% – 90%
t_{FallF}	Fall Time, Normal Strong Mode, Cload = 50 pF	2	–	18	ns	V_{DD} = 4.5 to 5.25 V, 10% – 90%
t_{RiseS}	Rise Time, Slow Strong Mode, Cload = 50 pF	10	27	–	ns	V_{DD} = 3 to 5.25 V, 10% – 90%
t_{FallS}	Fall Time, Slow Strong Mode, Cload = 50 pF	10	22	–	ns	V_{DD} = 3 to 5.25 V, 10% – 90%

Figure 13. GPIO Timing Diagram



AC Analog Output Buffer Specifications

The following tables list guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and –40 °C ≤ T_A ≤ 85 °C, or 3.0 V to 3.6 V and –40 °C ≤ T_A ≤ 85 °C, respectively. Typical parameters apply to 5 V and 3.3 V at 25 °C and are for design guidance only.

Table 50. 5 V AC Analog Output Buffer Specifications

Symbol	Description	Min	Typ	Max	Units	Notes
t_{ROB}	Rising Settling Time to 0.1%, 1 V Step, 100 pF Load					
	Power = Low	–	–	2.5	µs	
	Power = High	–	–	2.9	µs	
t_{SOB}	Falling Settling Time to 0.1%, 1 V Step, 100 pF Load					
	Power = Low	–	–	2.3	µs	
	Power = High	–	–	2.3	µs	
SR_{ROB}	Rising Slew Rate (20% to 80%), 1 V Step, 100 pF Load					
	Power = Low	0.65	–	–	V/µs	
	Power = High	0.65	–	–	V/µs	
SR_{FOB}	Falling Slew Rate (80% to 20%), 1 V Step, 100 pF Load					
	Power = Low	0.65	–	–	V/µs	
	Power = High	0.65	–	–	V/µs	
BW_{OB}	Small Signal Bandwidth, 20mV$_{pp}$, 3dB BW, 100 pF Load					
	Power = Low	0.8	–	–	MHz	
	Power = High	0.8	–	–	MHz	
BW_{OB}	Large Signal Bandwidth, 1 V$_{pp}$, 3dB BW, 100 pF Load					
	Power = Low	300	–	–	kHz	
	Power = High	300	–	–	kHz	

Table 51. 3.3 V AC Analog Output Buffer Specifications

Symbol	Description	Min	Typ	Max	Units	Notes
t_{ROB}	Rising Settling Time to 0.1%, 1 V Step, 100 pF Load					
	Power = Low	–	–	3.8	µs	
	Power = High	–	–	3.8	µs	
t_{SOB}	Falling Settling Time to 0.1%, 1 V Step, 100 pF Load					
	Power = Low	–	–	3.2	µs	
	Power = High	–	–	2.9	µs	
SR_{ROB}	Rising Slew Rate (20% to 80%), 1 V Step, 100 pF Load					
	Power = Low	0.5	–	–	V/µs	
	Power = High	0.5	–	–	V/µs	
SR_{FOB}	Falling Slew Rate (80% to 20%), 1 V Step, 100 pF Load					
	Power = Low	0.5	–	–	V/µs	
	Power = High	0.5	–	–	V/µs	
BW_{OB}	Small Signal Bandwidth, 20mV$_{pp}$, 3dB BW, 100 pF Load					
	Power = Low	0.64	–	–	MHz	
	Power = High	0.64	–	–	MHz	
BW_{OB}	Large Signal Bandwidth, 1 V$_{pp}$, 3dB BW, 100 pF Load					
	Power = Low	200	–	–	kHz	
	Power = High	200	–	–	kHz	

AC SAR10 ADC Specifications

The following table lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and –40 °C ≤ T_A ≤ 85 °C, or 3.0 V to 3.6 V and –40 °C ≤ T_A ≤ 85 °C, respectively. Typical parameters apply to 5 V and 3.3 V at 25 °C and are for design guidance only.

Table 52. AC SAR10 ADC Specifications

Symbol	Description	Min	Typ	Max	Units	Notes
$F_{INSAR10}$	Input clock frequency for SAR10 ADC	–	–	2.0	MHz	
F_{SSAR10}	Sample rate for SAR10 ADC SAR10 ADC Resolution = 10 bits	–	–	142.9	ksps	For 10-bit resolution, the sample rate is the ADC's input clock divided by 14.

AC External Clock Specifications

The following tables list guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and –40 °C ≤ T_A ≤ 85 °C, or 3.0 V to 3.6 V and –40 °C ≤ T_A ≤ 85 °C, respectively. Typical parameters apply to 5 V and 3.3 V at 25 °C and are for design guidance only.

Table 53. 5 V AC External Clock Specifications

Symbol	Description	Min	Typ	Max	Units	Notes
F_{OSCEXT}	Frequency	0.093	–	24.6	MHz	
–	High Period	20.6	–	5300	ns	
–	Low Period	20.6	–	–	ns	
–	Power-up IMO to Switch	150	–	–	µs	

Table 54. 3.3 V AC External Clock Specifications

Symbol	Description	Min	Typ	Max	Units	Notes
F_{OSCEXT}	Frequency with CPU Clock divide by 1[28]	0.093	–	12.3	MHz	
F_{OSCEXT}	Frequency with CPU Clock divide by 2 or greater[29]	0.186	–	24.6	MHz	
–	High Period with CPU Clock divide by 1	41.7	–	5300	ns	
–	Low Period with CPU Clock divide by 1	41.7	–	–	ns	
–	Power-up IMO to Switch	150	–	–	µs	

Notes
28. Maximum CPU frequency is 12 MHz at 3.3 V. With the CPU clock divider set to 1, the external clock must adhere to the maximum frequency and duty cycle requirements.
29. If the frequency of the external clock is greater than 12 MHz, the CPU clock divider must be set to 2 or greater. In this case, the CPU clock divider ensures that the fifty percent duty cycle requirement is met.

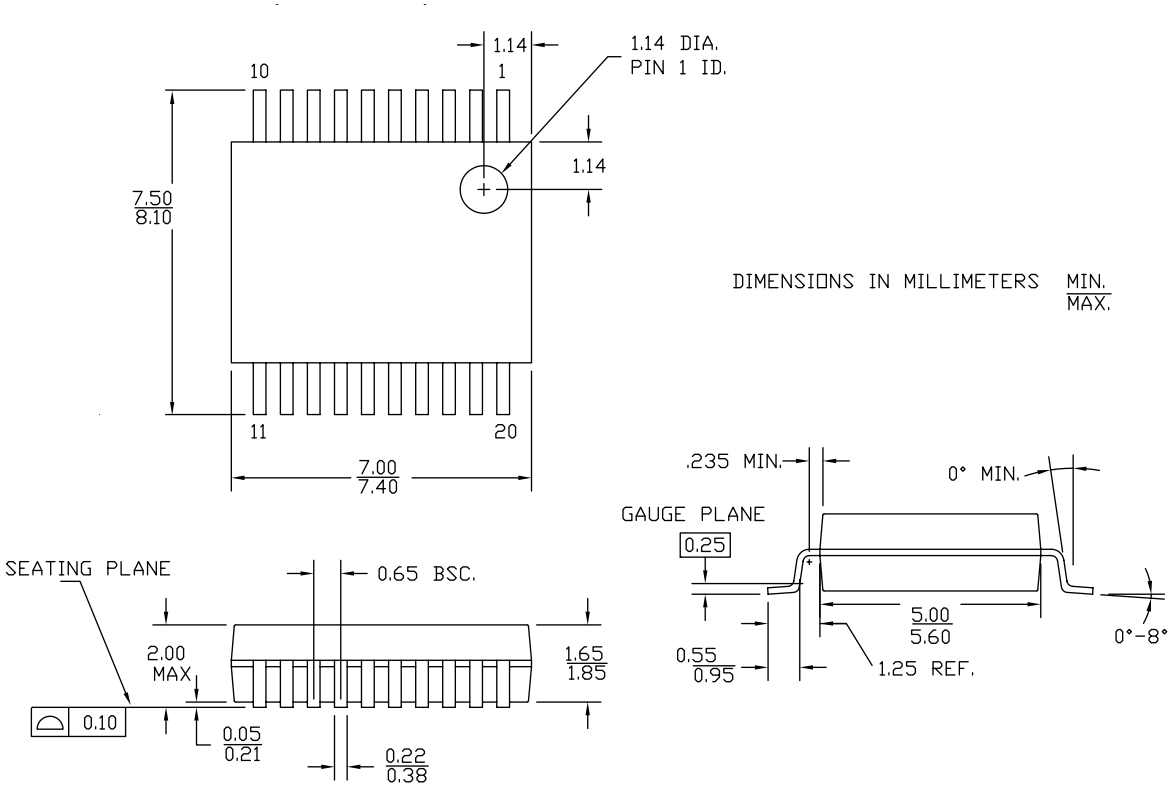
Packaging Information

This section illustrates the packaging specifications for the CY8C28xxx PSoC devices, along with the thermal impedances for each package and the typical package capacitance on crystal pins.

Important Note Emulation tools may require a larger area on the target PCB than the chip's footprint. For a detailed description of the emulation tools' dimensions, refer to the Emulator Pod Dimension drawings at http://www.cypress.com.

Packaging Dimensions

Figure 17. 20-pin SSOP (210 Mils) Package Outline O20.21, 51-85077



51-85077 *F

Figure 18. 28-pin SSOP (210 Mils) O28.21 Package Outline, 51-85079

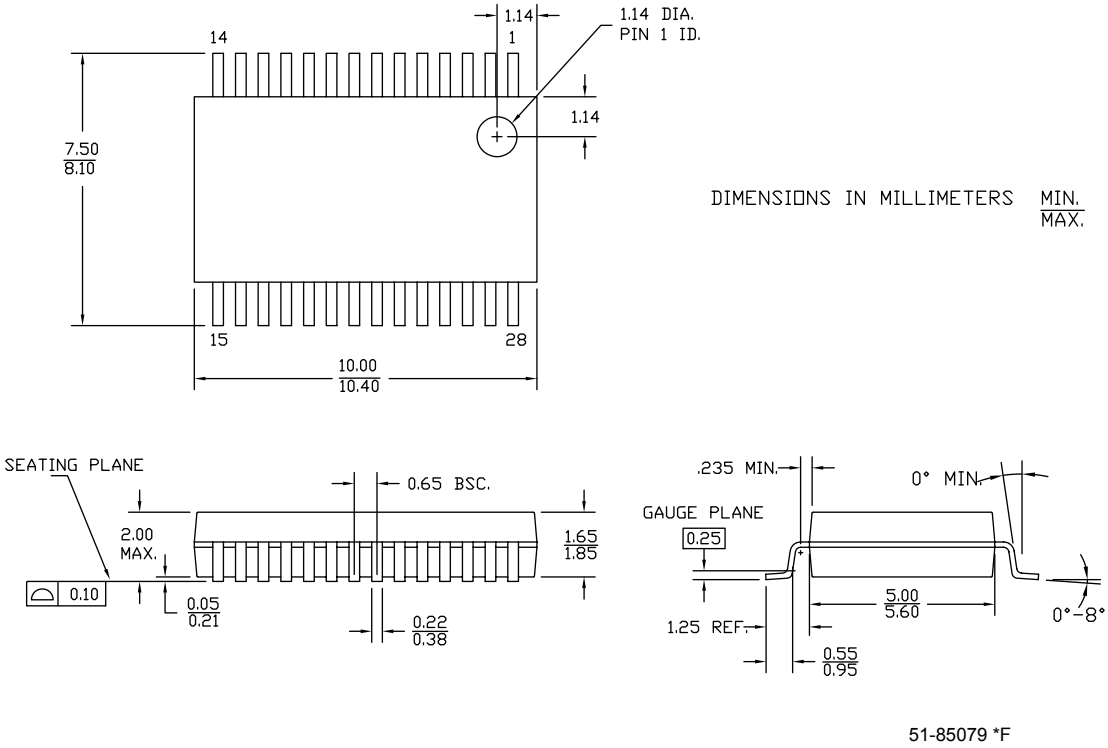
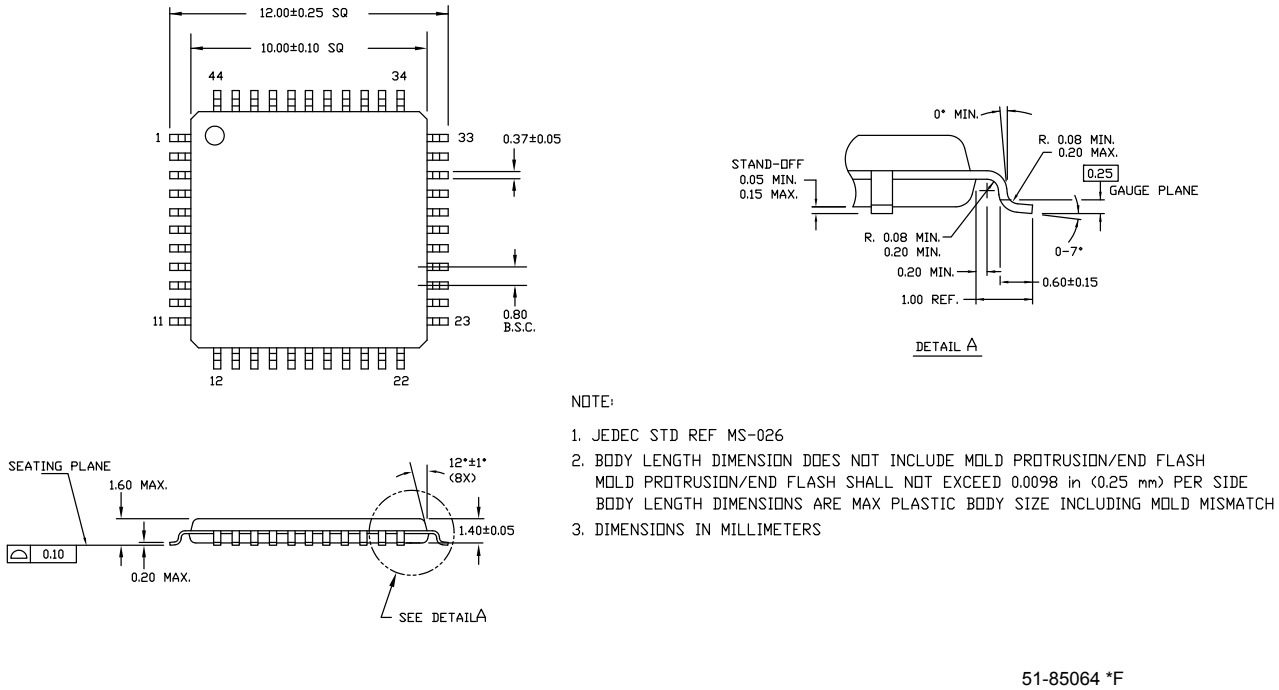


Figure 19. 44-pin TQFP (10 × 10 × 1.4 mm) A44S Package Outline, 51-85064



Development Tool Selection

This section presents the development tools available for all current PSoC device families including the CY8C28xxx family.

Software

PSoC Designer

At the core of the PSoC development software suite is PSoC Designer. Utilized by thousands of PSoC developers, this robust software has been facilitating PSoC designs for over half a decade. PSoC Designer is available free of charge at http://www.cypress.com.

PSoC Programmer

Flexible enough to be used on the bench in development, yet suitable for factory programming, PSoC Programmer works either as a standalone programming application or it can operate directly from PSoC Designer. PSoC Programmer software is compatible with both PSoC ICE-Cube In-Circuit Emulator and PSoC MiniProg. PSoC Programmer is available free of charge at http://www.cypress.com.

Development Kits

All development kits can be purchased from the Cypress Online Store.

CY3215-DK Basic Development Kit

The CY3215-DK is for prototyping and development with PSoC Designer. This kit supports in-circuit emulation and the software interface allows users to run, halt, and single step the processor and view the content of specific memory locations. Advanced emulation features are supported in PSoC Designer. The kit includes:

- PSoC Designer Software CD
- ICE-Cube In-Circuit Emulator
- Pod kit for CY8C29x66 PSoC Family
- Cat-5 Adapter
- Mini-Eval Programming Board
- 110 ~ 240 V Power Supply, Euro-Plug Adapter
- ISSP Cable
- USB 2.0 Cable and Blue Cat-5 Cable
- 2 CY8C29466-24PXI 28-PDIP Chip Samples

Evaluation Tools

All evaluation tools can be purchased from the Cypress Online Store.

CY3210-MiniProg1

The CY3210-MiniProg1 kit allows a user to program PSoC devices via the MiniProg1 programming unit. The MiniProg is a small, compact prototyping programmer that connects to the PC via a provided USB 2.0 cable. The kit includes:

- MiniProg Programming Unit
- MiniEval Socket Programming and Evaluation Board
- 28-Pin CY8C29466-24PXI PDIP PSoC Device Sample
- 28-Pin CY8C27443-24PXI PDIP PSoC Device Sample
- PSoC Designer Software CD
- Getting Started Guide
- USB 2.0 Cable

CY3210-PSoCEval1

The CY3210-PSoCEval1 kit features an evaluation board and the MiniProg1 programming unit. The evaluation board includes an LCD module, potentiometer, LEDs, and plenty of bread-boarding space to meet all of your evaluation needs. The kit includes:

- Evaluation Board with LCD Module
- MiniProg Programming Unit
- 28-Pin CY8C29466-24PXI PDIP PSoC Device Sample (2)
- PSoC Designer Software CD
- Getting Started Guide
- USB 2.0 Cable

Ordering Information

The following table lists the CY8C28xxx PSoC devices key package features and ordering codes.

Package	Ordering Code	Temperature Range	CapSense	Digital Blocks	Regular Analog Blocks	Limited Analog Blocks	HW I^2C	Decimators	10-bit SAR ADC	Digital I/O Pins	Analog Inputs	Analog Outputs	Flash (KBytes)	RAM (KBytes)	XRES Pin
28-Pin (210-Mil) SSOP	CY8C28403-24PVXI	–40 °C to 85 °C	N	12	0	0	2	0	Y	24	8	0	16	1	Y
28-Pin (210-Mil) SSOP (Tape and Reel)	CY8C28403-24PVXIT	–40 °C to 85 °C	N	12	0	0	2	0	Y	24	8	0	16	1	Y
28-Pin (210-Mil) SSOP	CY8C28413-24PVXI	–40 °C to 85 °C	Y	12	0	4	1	2	Y	24	24	0	16	1	Y
28-Pin (210-Mil) SSOP (Tape and Reel)	CY8C28413-24PVXIT	–40 °C to 85 °C	Y	12	0	4	1	2	Y	24	24	0	16	1	Y
44-Pin TQFP	CY8C28513-24AXI	–40 °C to 85 °C	Y	12	0	4	1	2	Y	40	40	0	16	1	Y
44-Pin TQFP (Tape and Reel)	CY8C28513-24AXIT	–40 °C to 85 °C	Y	12	0	4	1	2	Y	40	40	0	16	1	Y
48-Pin Sawn QFN	CY8C28623-24LTXI	–40 °C to 85 °C	N	12	6	0	2	2	N	44	10	2	16	1	Y
48-Pin Sawn QFN (Tape and Reel)	CY8C28623-24LTXIT	–40 °C to 85 °C	N	12	6	0	2	2	N	44	10	2	16	1	Y
28-Pin (210-Mil) SSOP	CY8C28433-24PVXI	–40 °C to 85 °C	Y	12	6	4	1	4	Y	24	24	2	16	1	Y
28-Pin (210-Mil) SSOP (Tape and Reel)	CY8C28433-24PVXIT	–40 °C to 85 °C	Y	12	6	4	1	4	Y	24	24	2	16	1	Y
20-Pin (210-Mil) SSOP	CY8C28243-24PVXI	–40 °C to 85 °C	N	12	12	0	2	4	Y	16	16	4	16	1	Y
20-Pin (210-Mil) SSOP (Tape and Reel)	CY8C28243-24PVXIT	–40 °C to 85 °C	N	12	12	0	2	4	Y	16	16	4	16	1	Y
48-Pin Sawn QFN	CY8C28643-24LTXI	–40 °C to 85 °C	N	12	12	0	2	4	Y	44	44	4	16	1	Y
48-Pin Sawn QFN (Tape and Reel)	CY8C28643-24LTXIT	–40 °C to 85 °C	N	12	12	0	2	4	Y	44	44	4	16	1	Y
28-Pin (210-Mil) SSOP	CY8C28445-24PVXI	–40 °C to 85 °C	Y	12	12	4	2	4	Y	24	24	4	16	1	Y
28-Pin (210-Mil) SSOP (Tape and Reel)	CY8C28445-24PVXIT	–40 °C to 85 °C	Y	12	12	4	2	4	Y	24	24	4	16	1	Y
44-Pin TQFP	CY8C28545-24AXI	–40 °C to 85 °C	Y	12	12	4	2	4	Y	40	40	4	16	1	Y
44-Pin TQFP (Tape and Reel)	CY8C28545-24AXIT	–40 °C to 85 °C	Y	12	12	4	2	4	Y	40	40	4	16	1	Y
48-Pin Sawn QFN	CY8C28645-24LTXI	–40 °C to 85 °C	Y	12	12	4	2	4	Y	44	44	4	16	1	Y
48-Pin Sawn QFN (Tape and Reel)	CY8C28645-24LTXIT	–40 °C to 85 °C	Y	12	12	4	2	4	Y	44	44	4	16	1	Y
28-Pin (210-Mil) SSOP	CY8C28452-24PVXI	–40 °C to 85 °C	Y	8	12	4	1	4	N	24	24	4	16	1	Y
28-Pin (210-Mil) SSOP (Tape and Reel)	CY8C28452-24PVXIT	–40 °C to 85 °C	Y	8	12	4	1	4	N	24	24	4	16	1	Y
56-Pin SSOP OCD	CY8C28000-24PVXI	–40 °C to 85 °C	Y	12	12	4	2	4	Y	44	44	4	16	1	Y

Note For Die sales information, contact a local Cypress sales office or Field Applications Engineer (FAE).

Document History Page

Document Title: CY8C28243/CY8C28403/CY8C28413/CY8C28433/CY8C28445/CY8C28452/CY8C28513/CY8C28545/ CY8C28623/CY8C28643/CY8C28645, PSoC® Programmable System-on-Chip™ Document Number: 001-48111				
Revision	**ECN**	**Origin of Change**	**Submission Date**	**Description of Change**
**	2593460	BTK / PYRS	10/20/08	New document (Revision **).
*A	2652217	BTK / PYRS	02/02/09	Extensive updates to content. Added registers maps. Updated Getting Started section Updated Development Tools section Added some SAR10 ADC specifications. Added more analog system figures
*B	2675937	BTK	03/18/09	Updated DC Analog Reference Specifications tables Minor content updates
*C	2679015	HMI	03/26/2009	Post to external web.
*D	2750217	TDU	08/10/09	Updates to Electrical Specifications section Minor content updates
*E	2768143	TDU	09/23/09	Updated DC Operational Amplifier, DC Analog Reference, DC SAR10ADC, and DC POR specifications; Added Figure 15 and Figure 16; Updated AC TypeE-Operational and AC SAR10ADC specifications
*F	2805324	ALH	11/11/09	Added Contents page. Updated Electrical Specifications.
*G	2902396	NJF	03/30/2010	Updated Cypress website links. Added $T_{BAKETEMP}$ and $T_{BAKETIME}$ parameters in Absolute Maximum Ratings. Updated DC SAR10 ADC Specifications. Modified Note 23. Removed AC Analog Mux Bus Specifications, Third Party Tools and Build a PSoC Emulator into your Board. Updated Packaging Information and Ordering Code Definitions. Updated links in Sales, Solutions, and Legal Information.
*H	3063584	NJF	10/20/10	Added PSoC Device Characteristics table. Added DC I2C Specifications table. Added F32K_U max limit. Added Tjit_IMO specification, removed existing jitter specifications. Updated Analog reference tables. Updated Units of Measure, Acronyms, Glossary, and References sections. Updated solder reflow specifications. No specific changes were made to AC Digital Block Specifications table and I2C Timing Diagram. They were updated for clearer understanding. Updated Figure 13 since the labelling for y-axis was incorrect. Template and styles update.
*I	3148779	NJF	01/20/11	Added Footnote # 34 to Thermal Impedances section. Table 7. 56-Pin Part Pinout (SSOP) (page 15) - Pin#28 - Pin Name changed to “V_{SS}”. Table 5. 44-Pin Part Pinout (TQFP) (page 13) - Pin#17 - Pin Type changed to “Power”. Under DC SAR10 ADC Specifications table, for parameter $V_{VREFSAR10}$, Max value changed from 4.95 V to V_{DD} – 0.3 V. Updated Table 59, “Solder Reflow Specifications,” on page 72 as per spec 25-00090.
*J	3598237	LURE / XZNG	04/24/2012	Changed the PWM description string from “8- to 32-bit” to “8- and 16-bit”.
*K	3758002	GULA	10/01/2012	Updated Packaging Information (spec 001-45616 (Changed revision from *B to *D), spec 51-85062 (Changed revision from *D to *F)).